



FUTURE  
CIRCULAR  
COLLIDER



Istituto Nazionale di Fisica Nucleare



A.D. 1308  
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UNIVERSITÀ DEGLI STUDI  
DI PERUGIA

Joint MDI and detectors: Beam pipe, vertex detectors, LumiCa

# Vertex detector cooling simulations

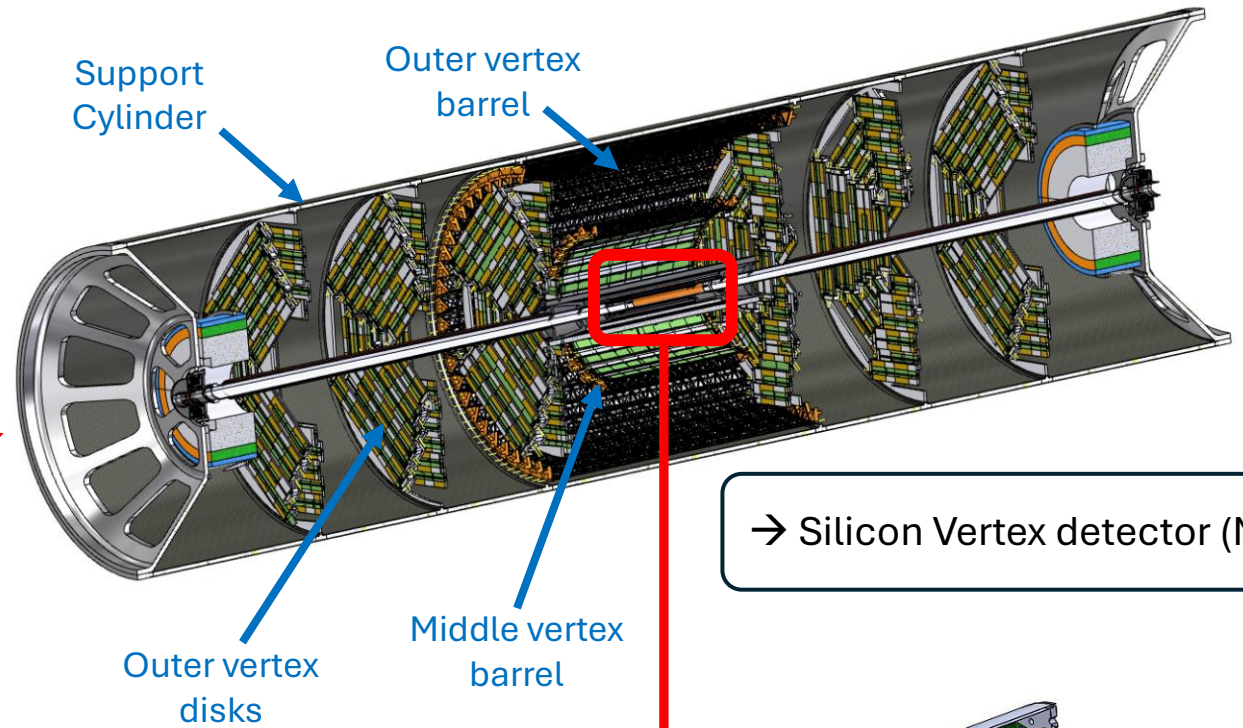
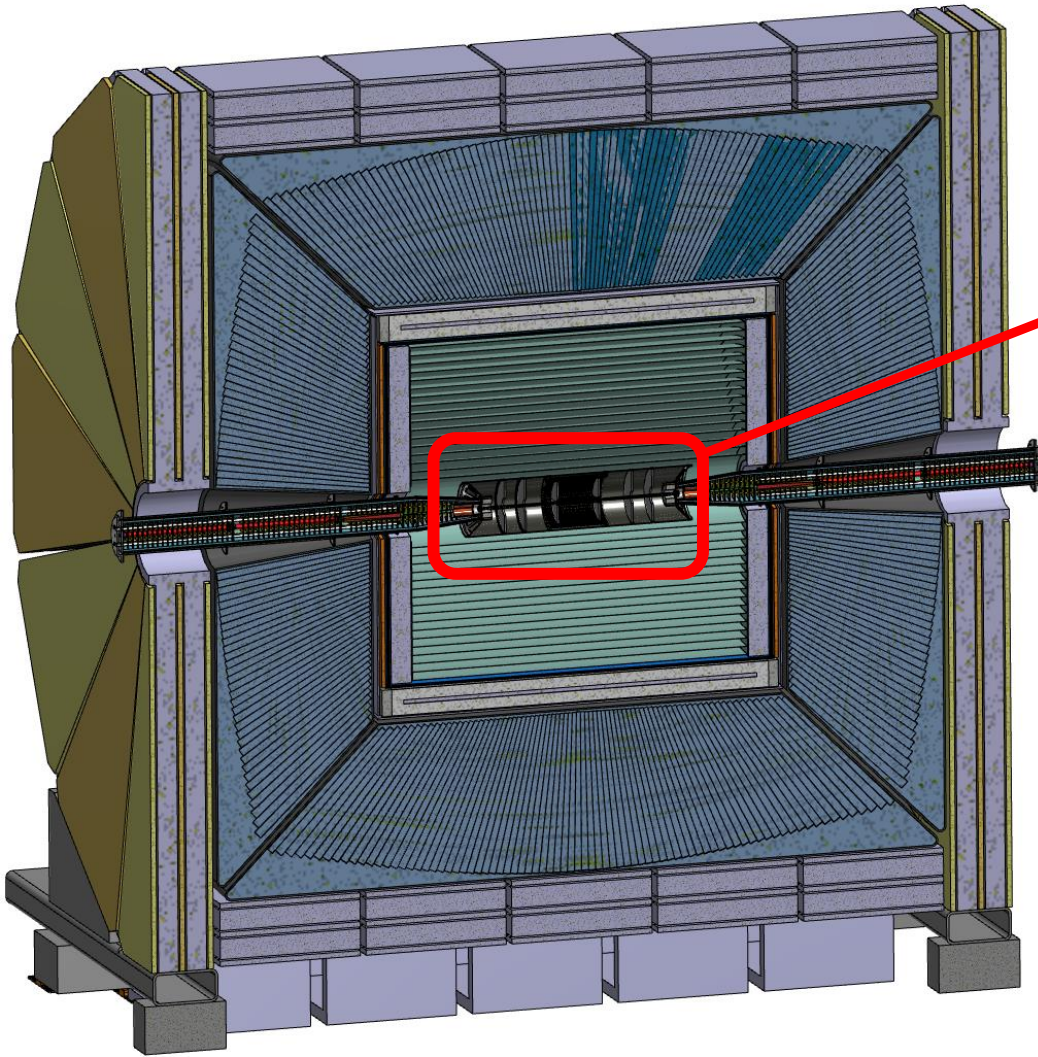
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(1) *Università degli Studi di Perugia*

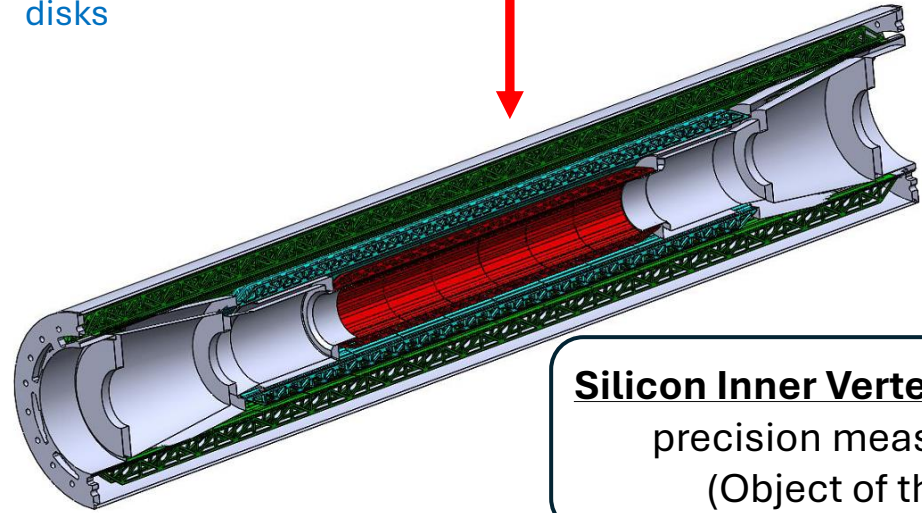
(2) *Istituto Nazionale di Fisica Nucleare – INFN - Sezione di Perugia*

(3) *Istituto Nazionale di Fisica Nucleare – INFN - Sezione di Pisa*

# THE IDEA DETECTOR CONCEPT



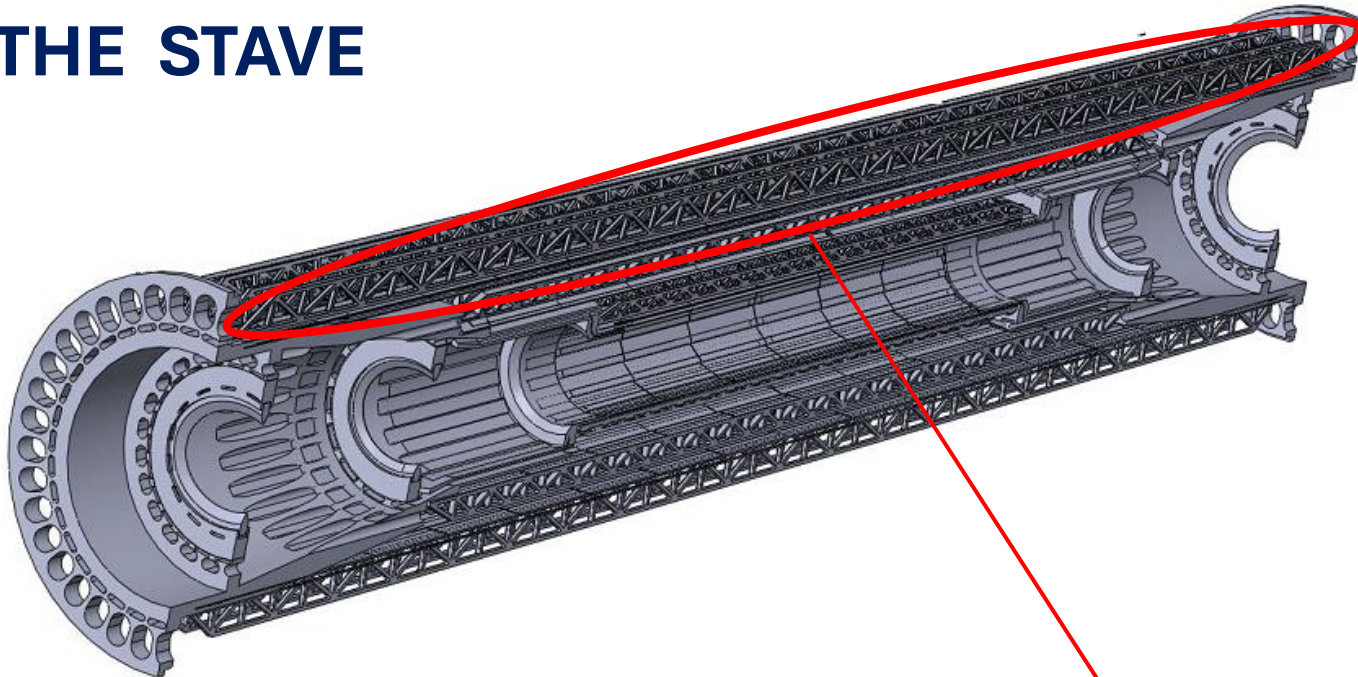
→ Silicon Vertex detector (MAPS)



**Silicon Inner Vertex Detector** for precision measurements (Object of this talk)



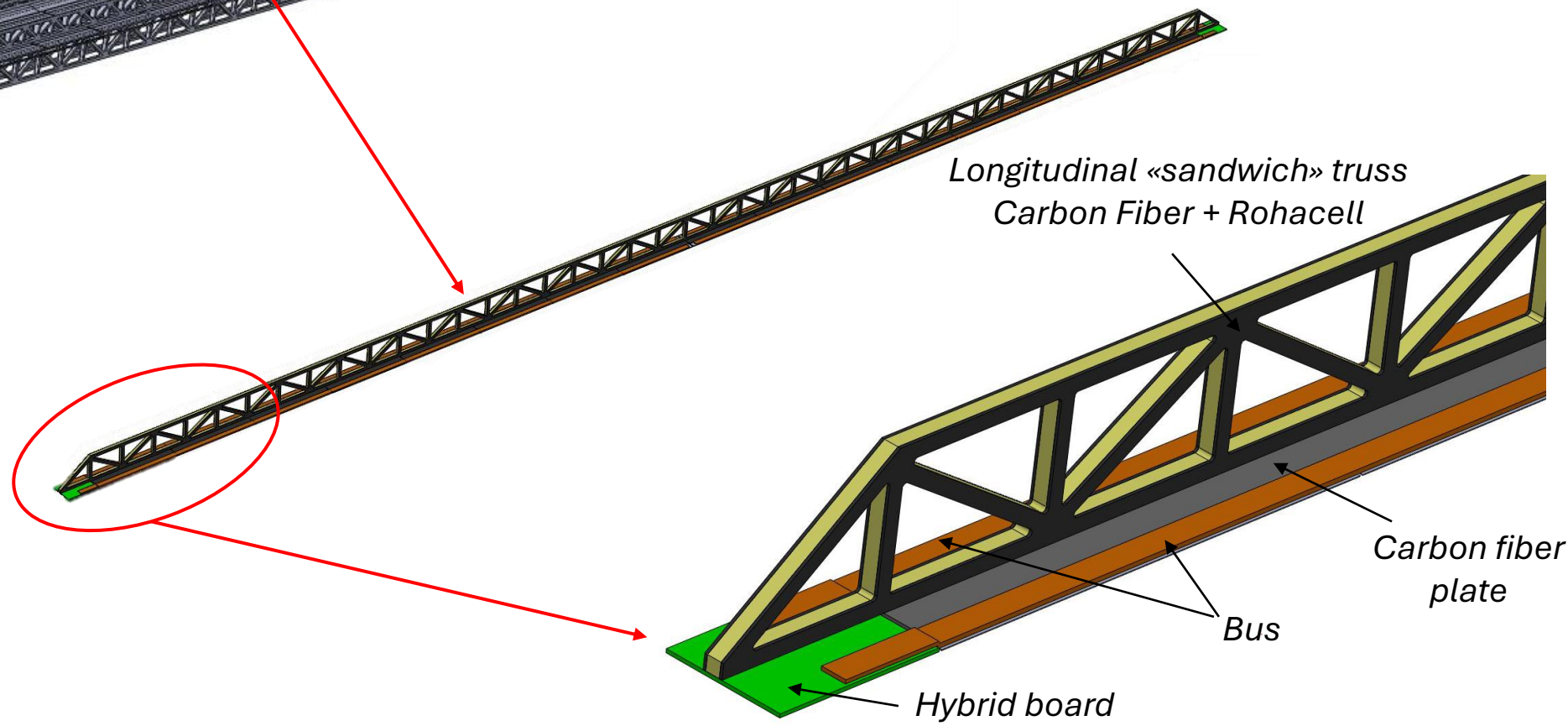
# THE STAVE



- The detector is made of lightweight longitudinal elements (“staves”) supported by endcaps at the ends:

- 36 staves in **layer 3**, 16 Modules each, L = 540mm
- 24 staves in **layer 2**, 10 Modules each, L = 340mm
- 15 staves in **layer 1**, 6 Modules each, L = 220mm

- Reticular lightweight support to provide stiffness.
- Thin carbon fiber walls interleaved with Rohacell.
- 2 buses (data and power).
- 1.8 mm wide and 250 μm thick (50 μm Al, 200 μm kapton) per side.
- Inspired to low mass hybrid R&D.
- Sensors facing interaction point w/o any other material in front.
- Readout chips either sides.



Longitudinal «sandwich» truss  
Carbon Fiber + Rohacell

Carbon fiber plate

Bus

Hybrid board

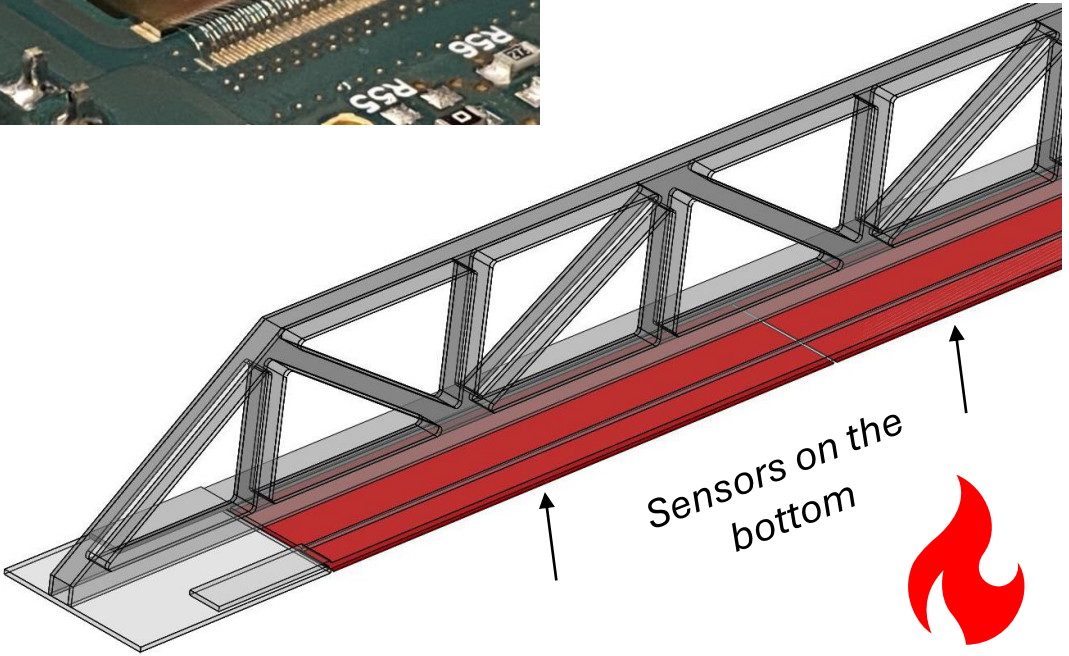
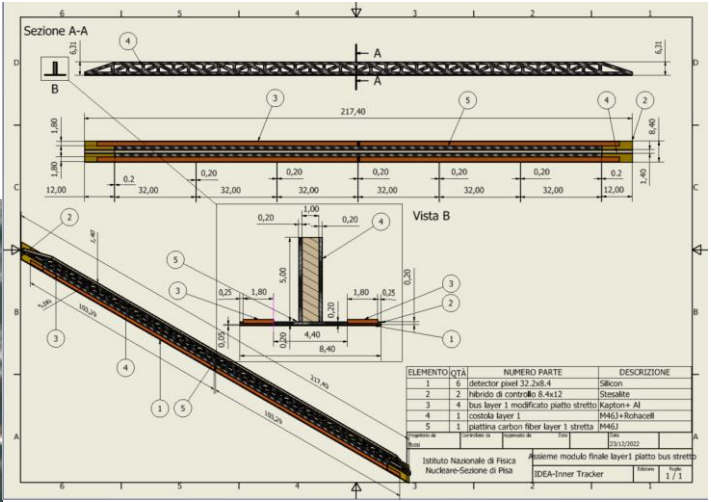
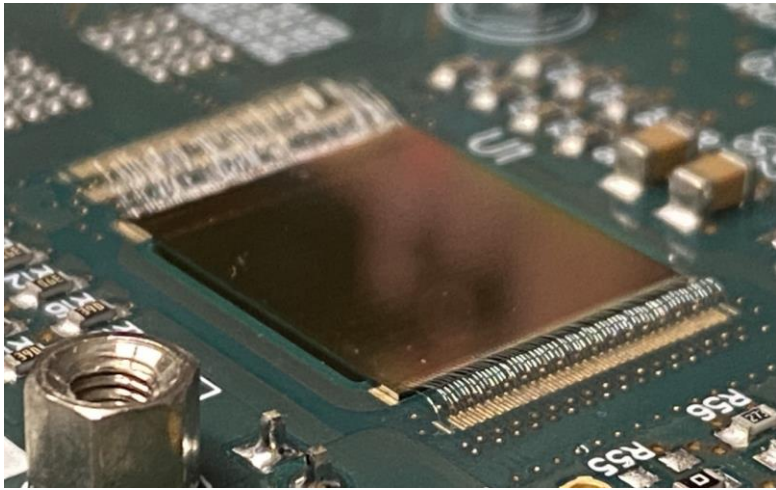
# SENSORS

- Sensors are positioned in the bottom face of each stave.

Modules of  $25 \times 25 \mu\text{m}^2$  pixel size

- **Inner Vertex (ARCADIA based):**

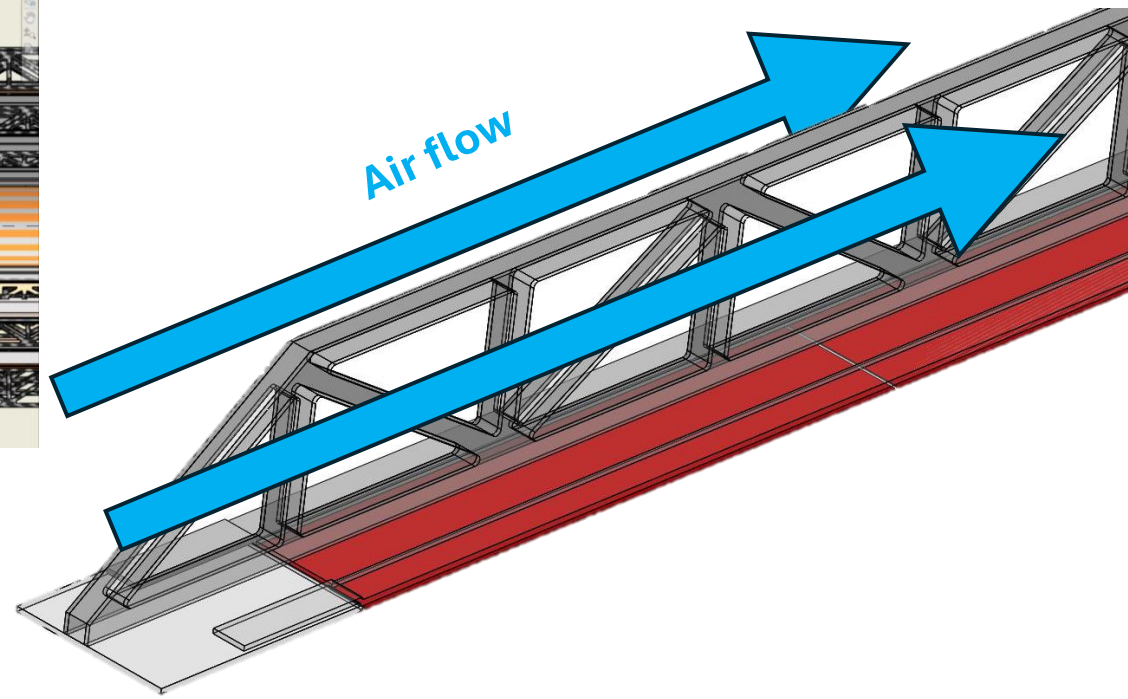
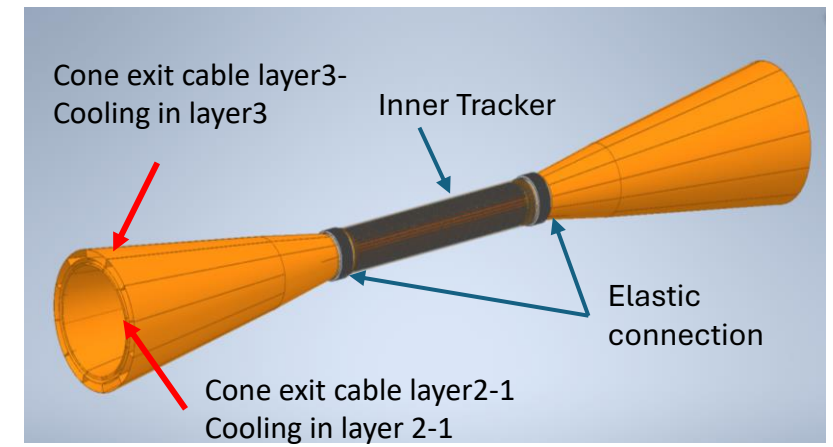
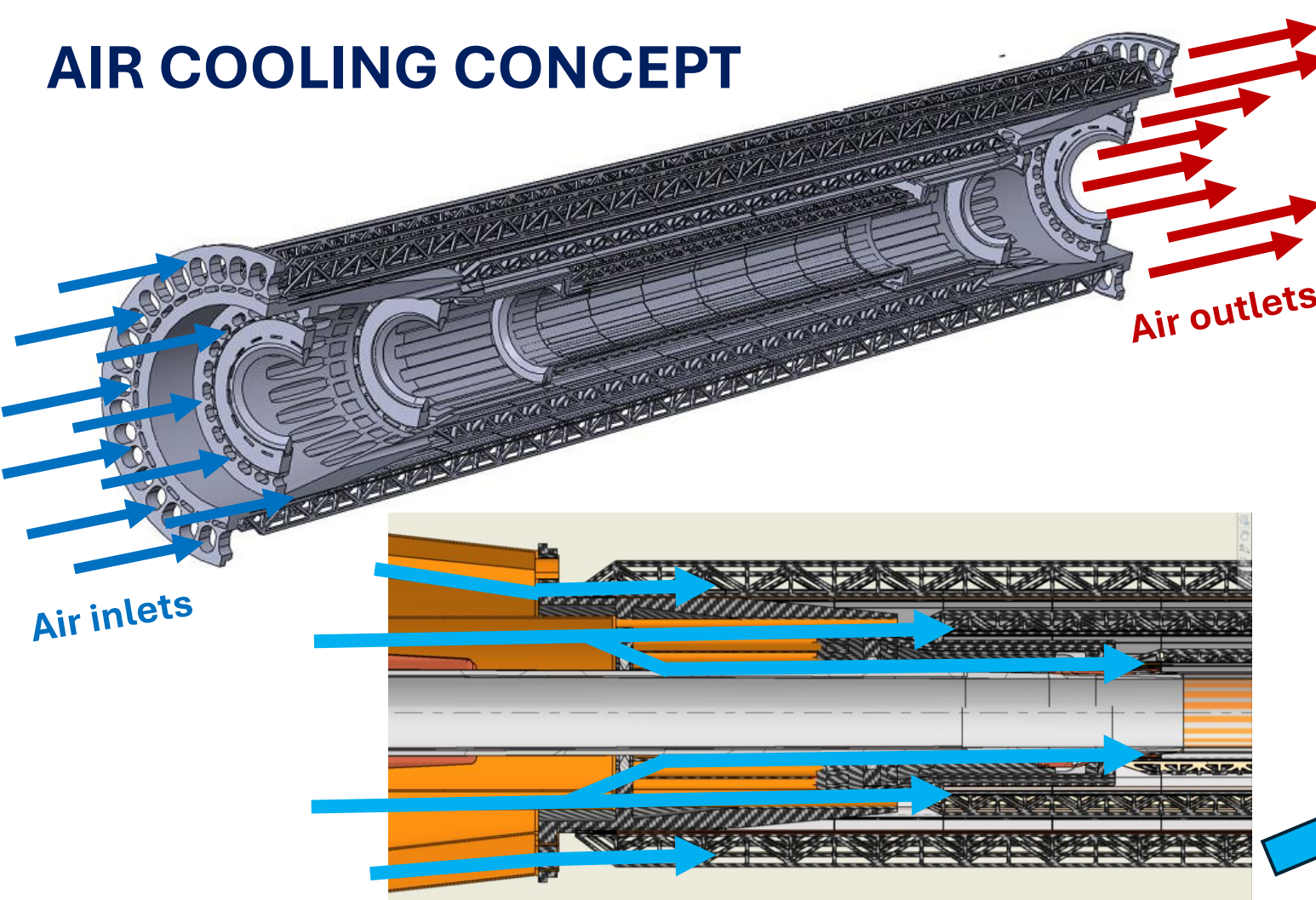
- Lfoundry 110 nm process
- 50  $\mu\text{m}$  thick
- Module Dimensions:  $8.4 \times 32 \text{ mm}^2$
- Power density 50  $\text{mW}/\text{cm}^2$
- 100  $\text{MHz}/\text{cm}^2$



- Estimation for sensors power dissipation:
  - Layer 3:  $\dot{Q} \sim 77 \text{ W}$  (total)
  - Layer 2:  $\dot{Q} \sim 32 \text{ W}$  (total)
  - Layer 1:  $\dot{Q} \sim 12 \text{ W}$  (total)



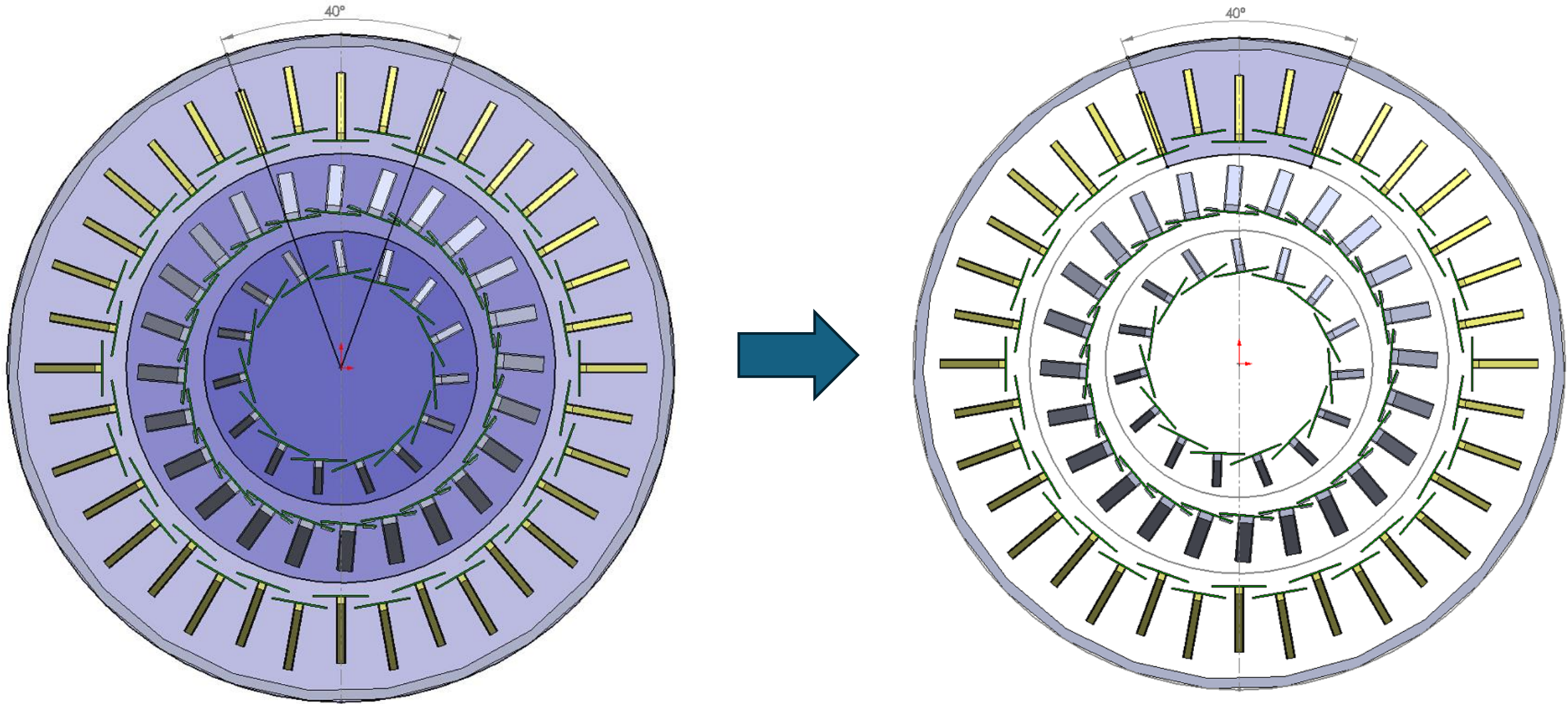
# AIR COOLING CONCEPT



- Cooling method: longitudinal air flow along the the detector.
- Temperature of air at the inlet:  $T_{\text{air}} = 15^{\circ}\text{C}$
- The air flow has the same direction for all the layers

# HISTORY - FIRST ATTEMPT: FOCUS ON LAYER 3

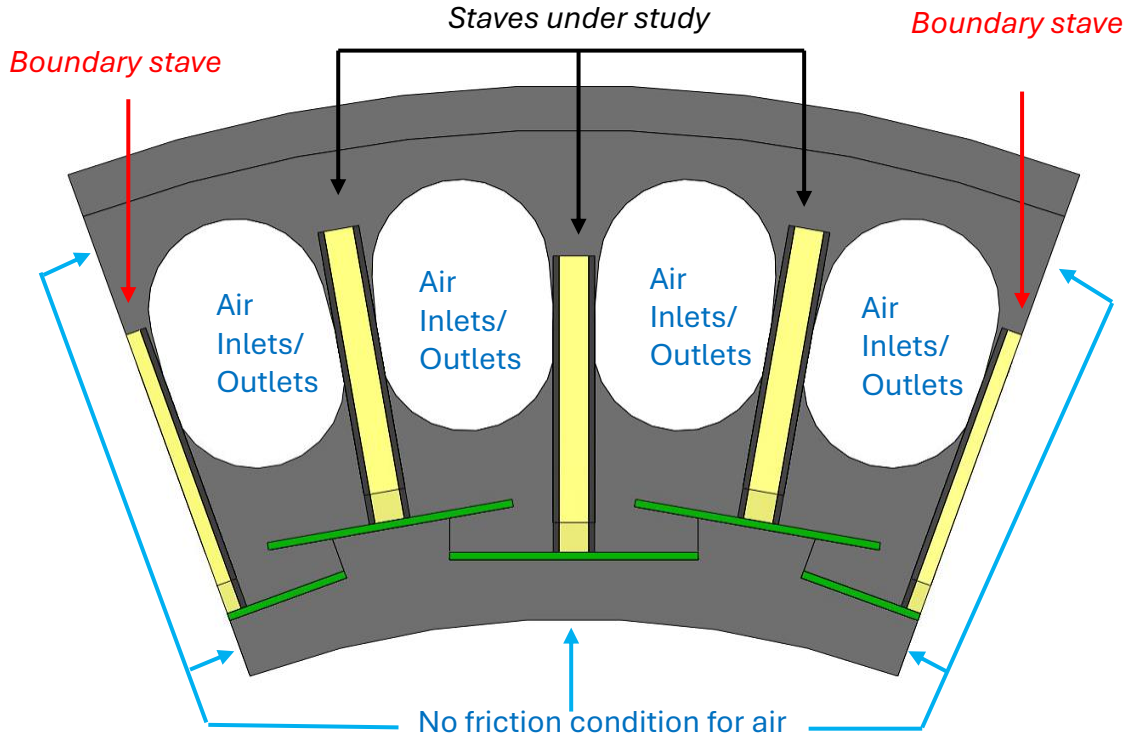
- Layer 3 has the max. length and power dissipation



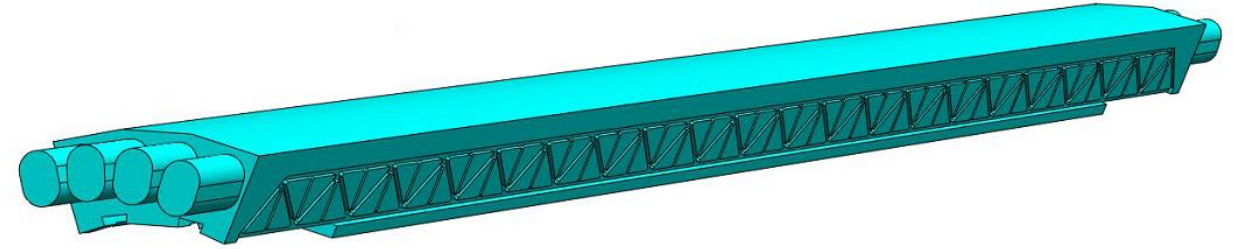
- Given the complexity of geometry, only a 40° sector of layer 3 was simulated.
- In the last model, the section plane passes exactly on the center of the staves.



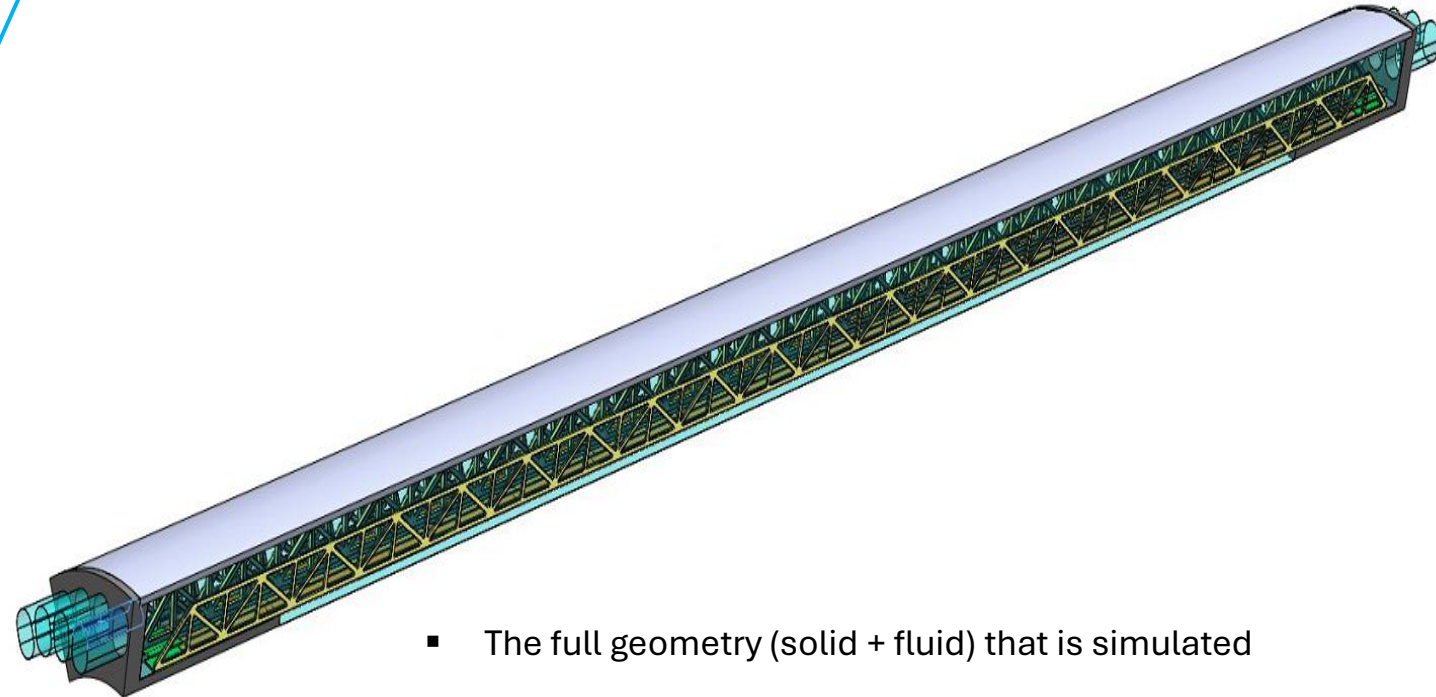
# HISTORY - FIRST ATTEMPT: FOCUS ON LAYER 3



- Both the solid and fluid domains are simulated at the same time (Conjugate heat transfer). The fluid volume is so modeled and added to the geometry.



- Set 5% of turbulence at inlets (Ansys default value)

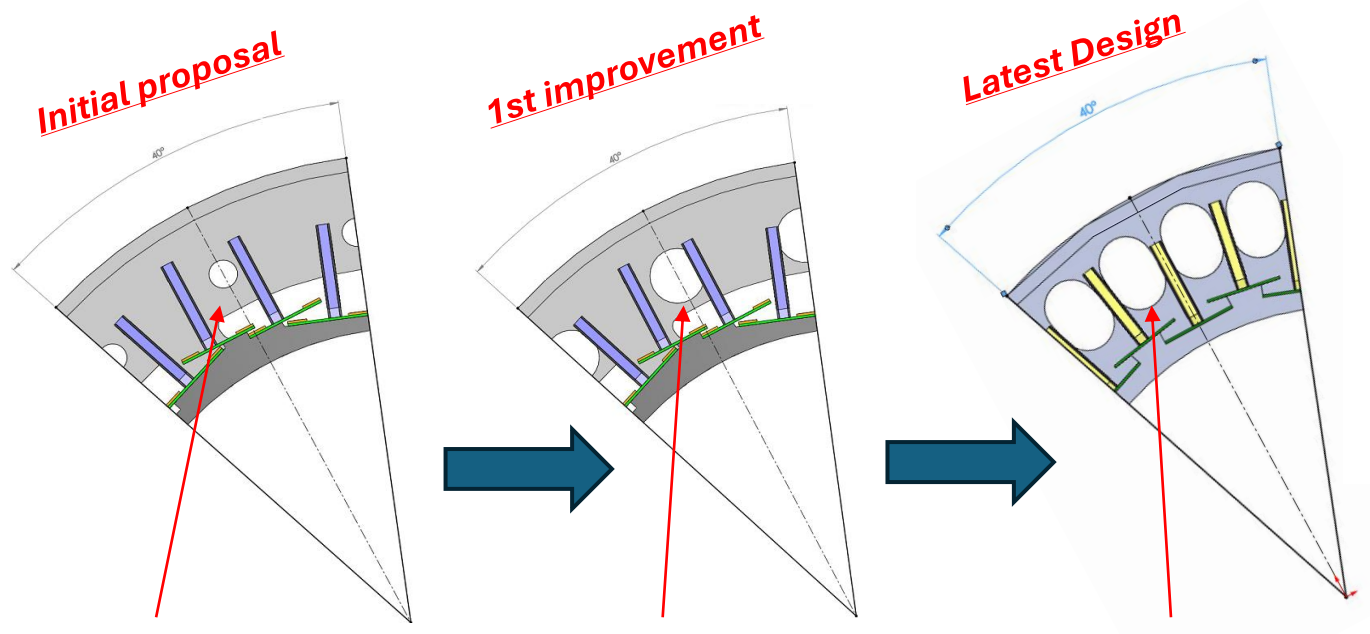


- The full geometry (solid + fluid) that is simulated

- ✓ Steady state conditions
- ✓ Turbulent flow: Reynolds Average Navier Stokes (RANS)
- ✓ Viscous model k- $\omega$  SST
- ✓ Pressure based solver
- ✓ No radiation heat exchange
- ✓ Volumetric constant power source on sensors volume

# DESIGN OPTIMIZATION OF LAYER 3

- Some improvements in the last year in the layer 3 geometry
  - Increasing inlets section
  - Increasing number of inlets
  - Moving staves to a radial configuration



Inlets: hole Ø3mm

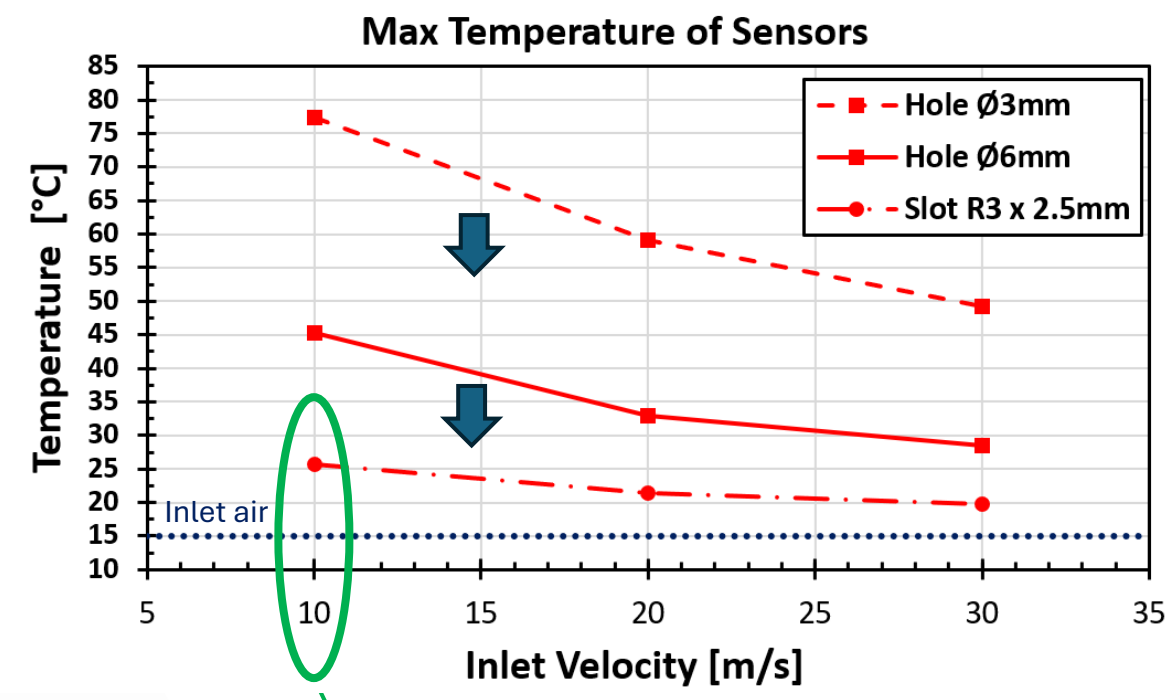
Section: 7 mm<sup>2</sup> per hole

Inlets: hole Ø6mm

Section: 28 mm<sup>2</sup> per hole

Inlets: slot R3 x 2.5mm

Section: 43 mm<sup>2</sup> per slot

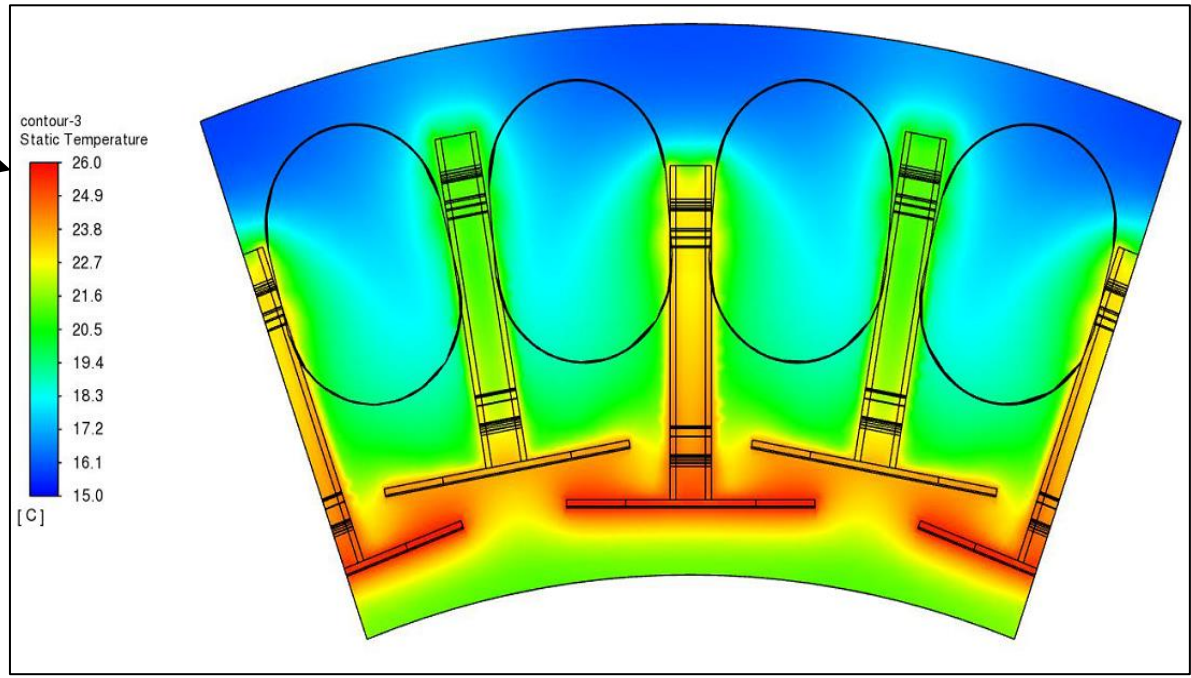
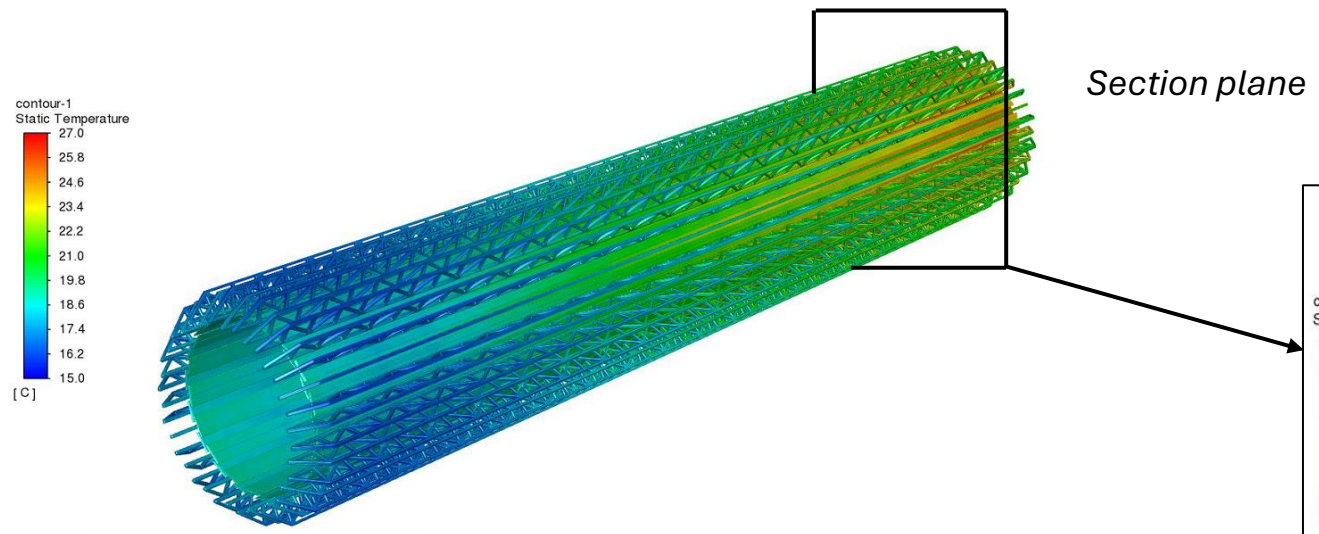


With current design, maximum temperature of **26°C** with  $V_{in} = 10 \text{ m/s}$  and  $15^\circ\text{C}$  is reached.

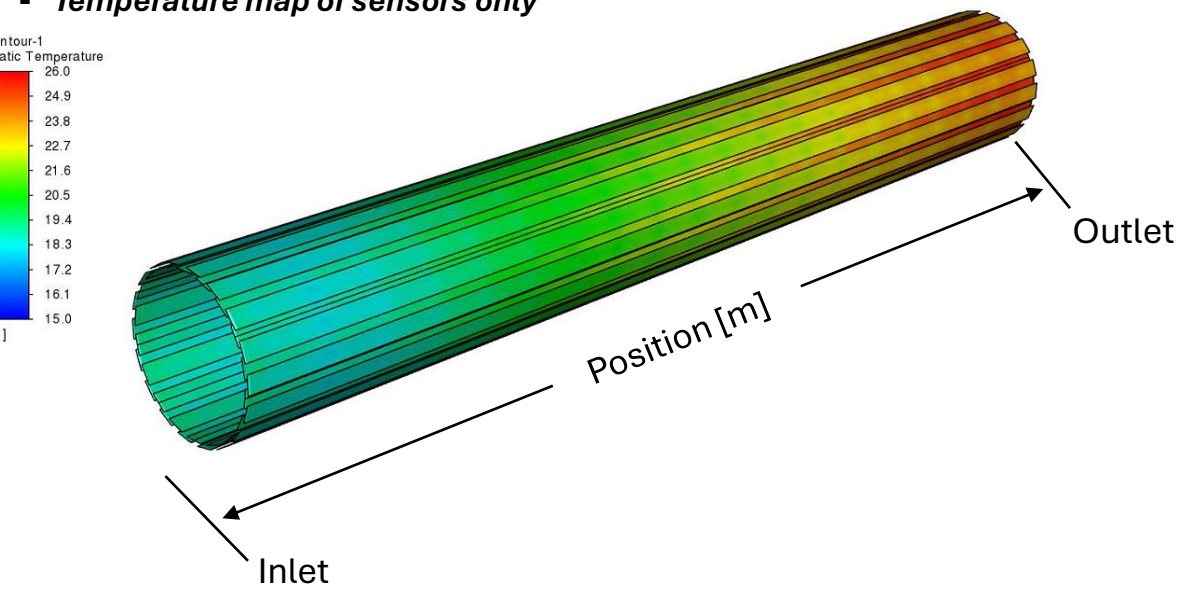


# LAYER 3 - TEMPERATURE

- Temperature map of sensors + staves

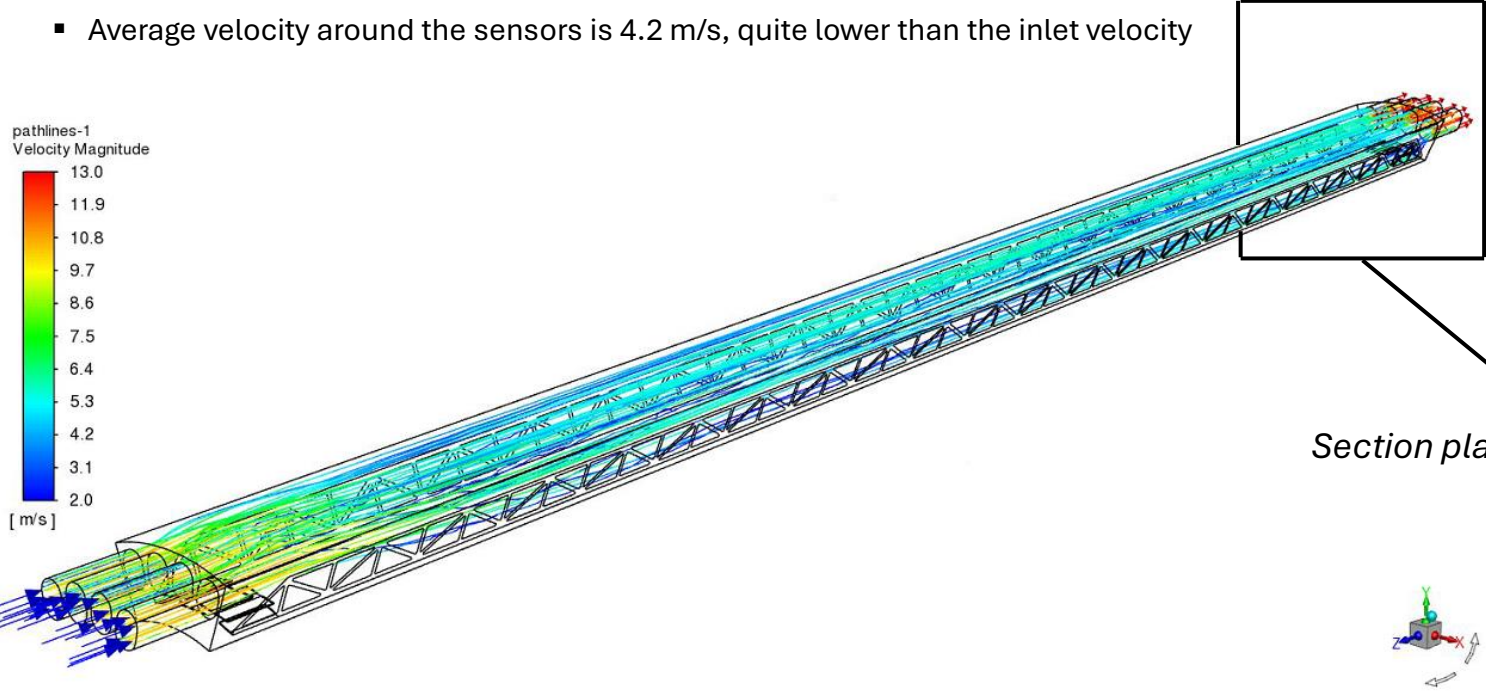
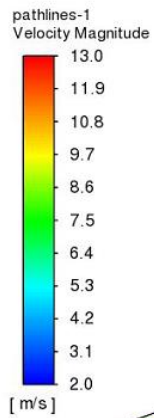


- Temperature map of sensors only

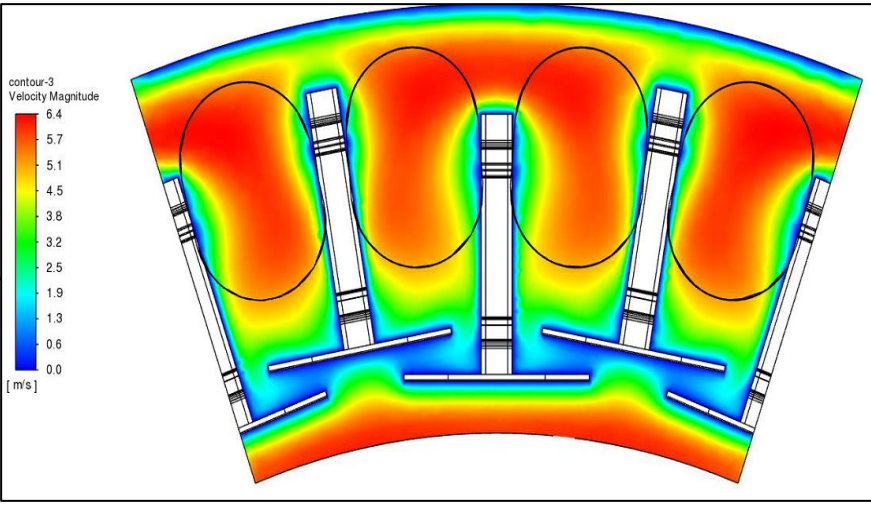


# LAYER 3 - VELOCITY

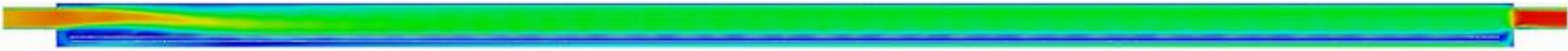
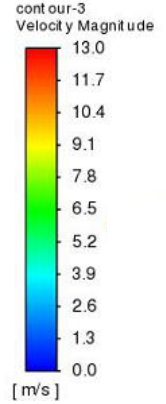
- Average velocity around the sensors is 4.2 m/s, quite lower than the inlet velocity



Section plane



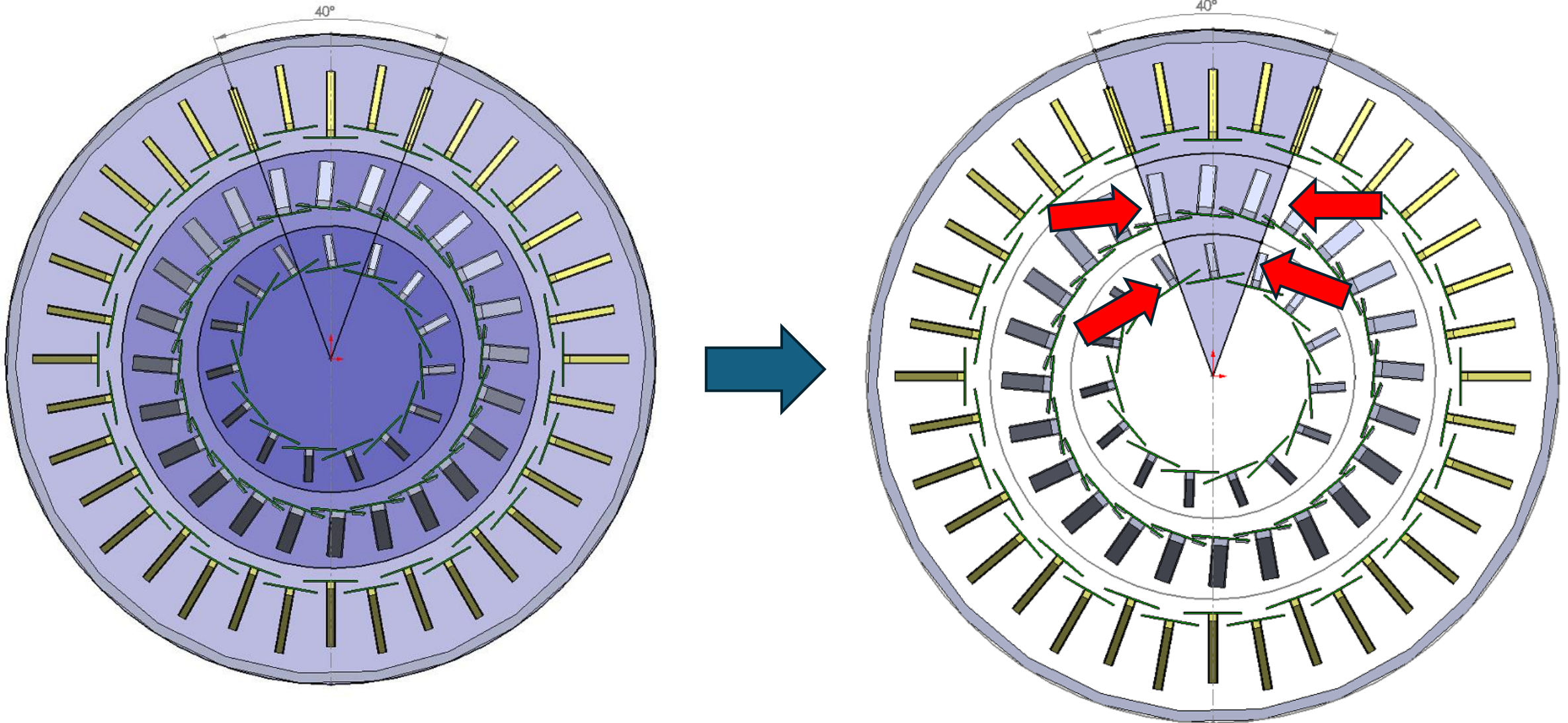
- Longitudinal section:





# INCLUDING ALSO LAYER 2 AND LAYER 1

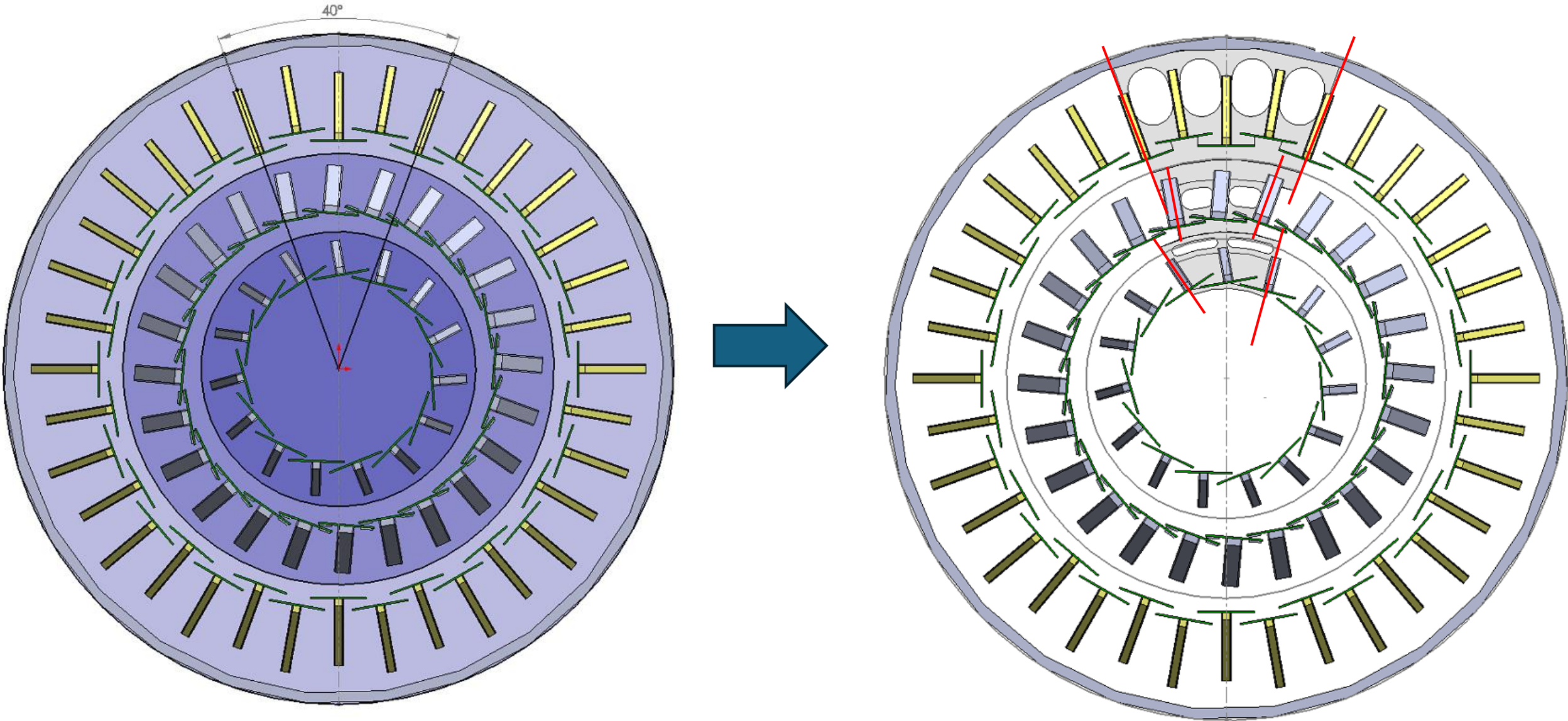
Challenge: layer 2 and layer 1 are rotated and any cutting plane does not fall on the middle of the stave of all layers



A straight cutting plane will brake the simmetry in the model, enhancing simulation complexity.

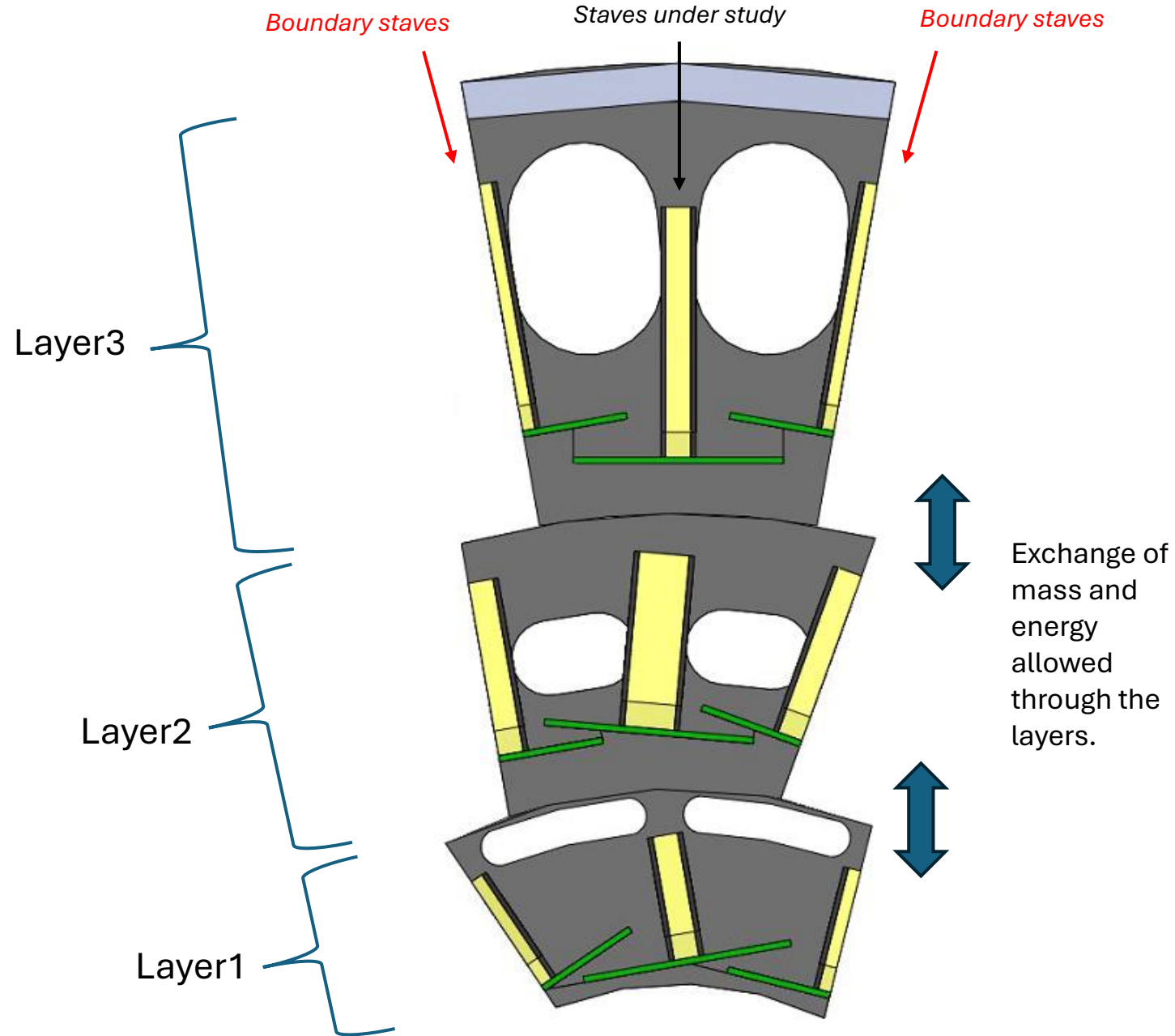
# INCLUDING ALSO LAYER 2 AND LAYER 1

- It has been decided to preserve the cutting at the center of each stave, by introducing multiple cutting lines.





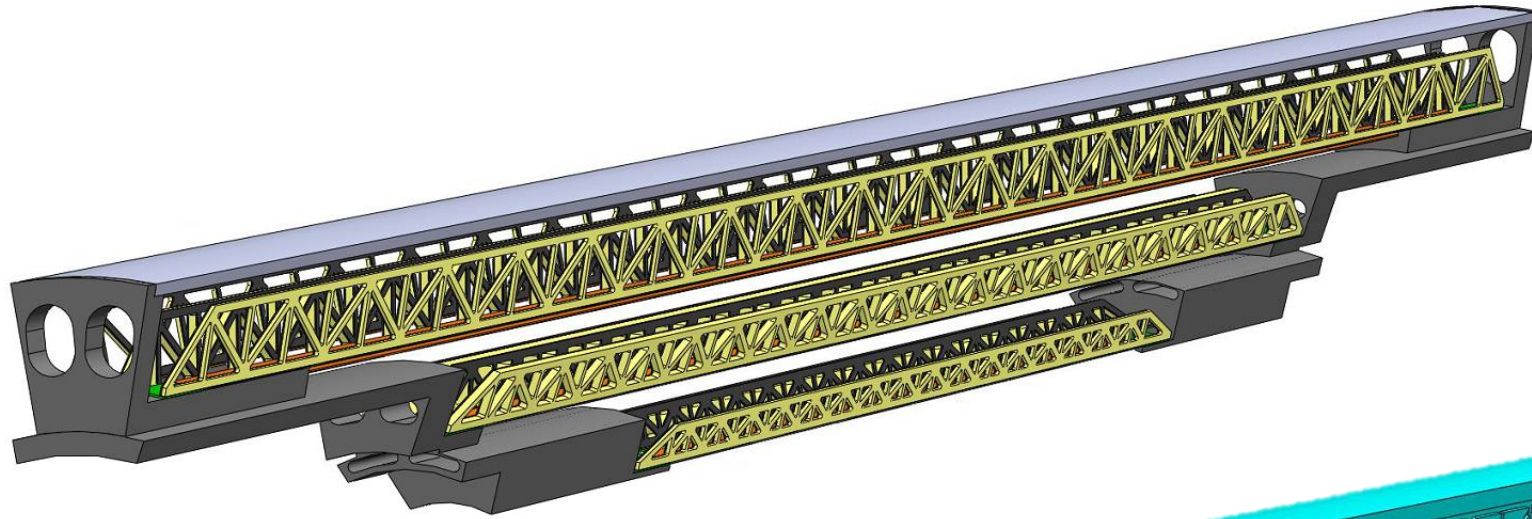
# INCLUDING ALSO LAYER 2 AND LAYER 1 - DOMAIN ANALYSED



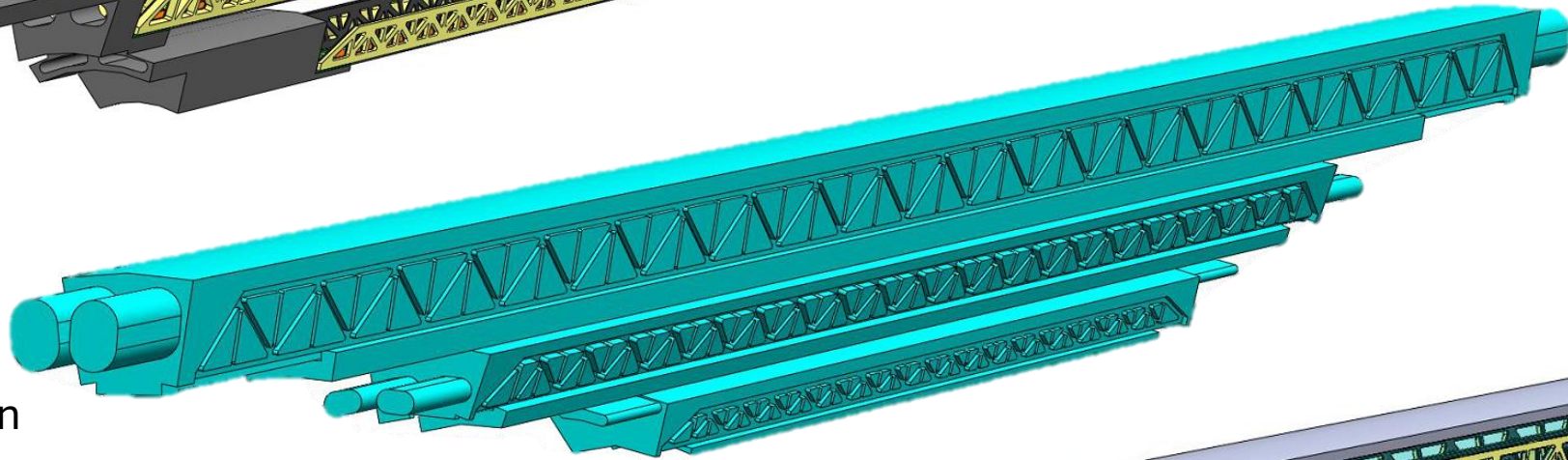
Inspired by Taipei tower 101

# THE FULL GEOMETRY

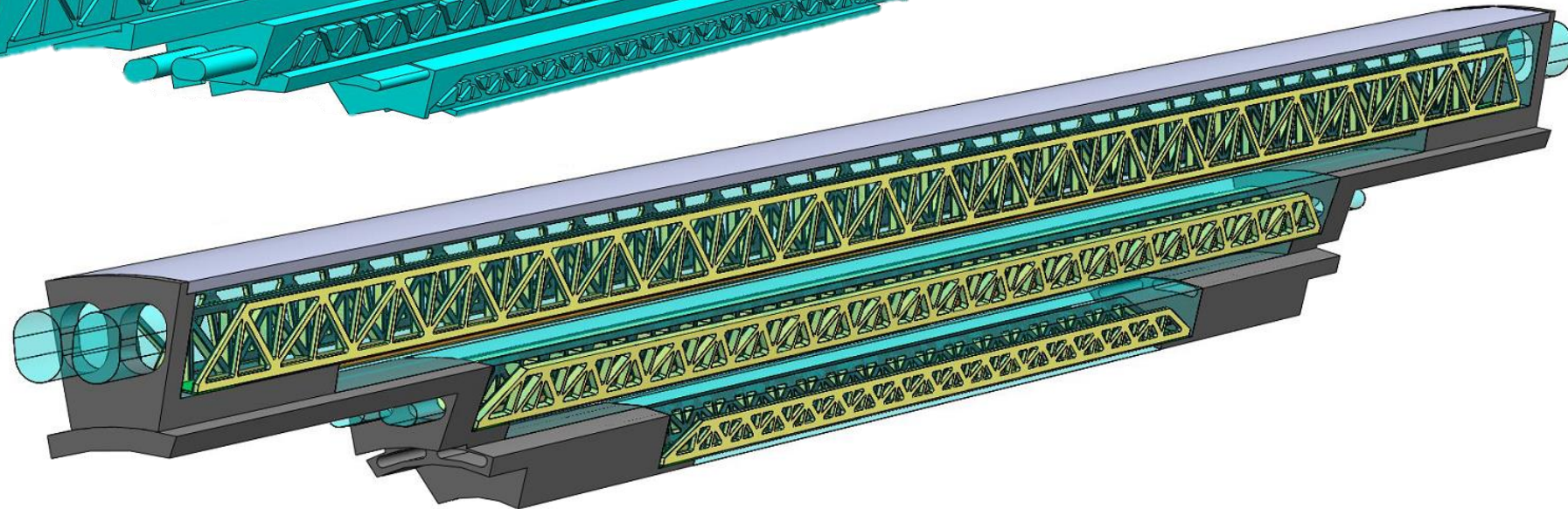
Meshing this model took about 30 Million of elements



Solid domain



Fluid domain

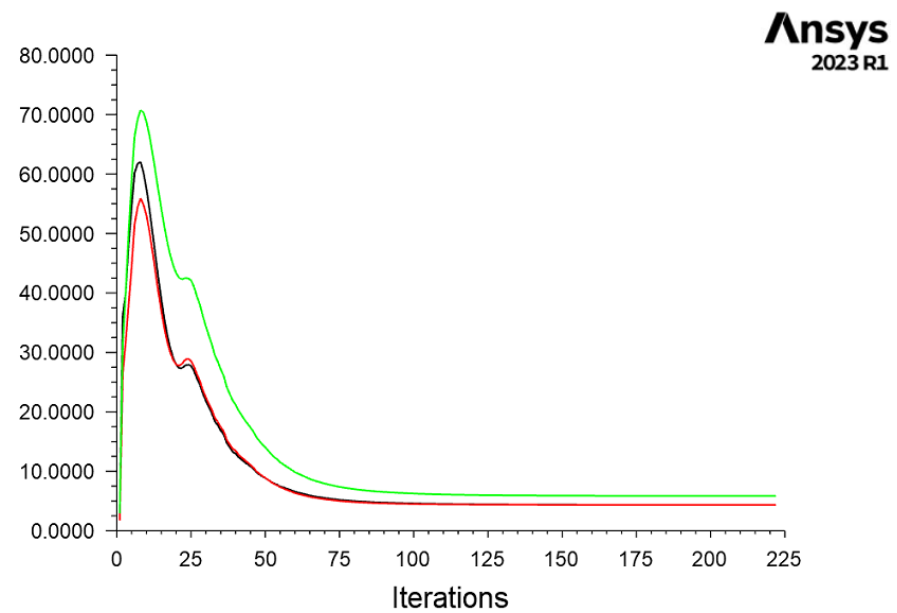
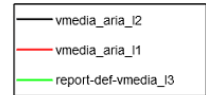
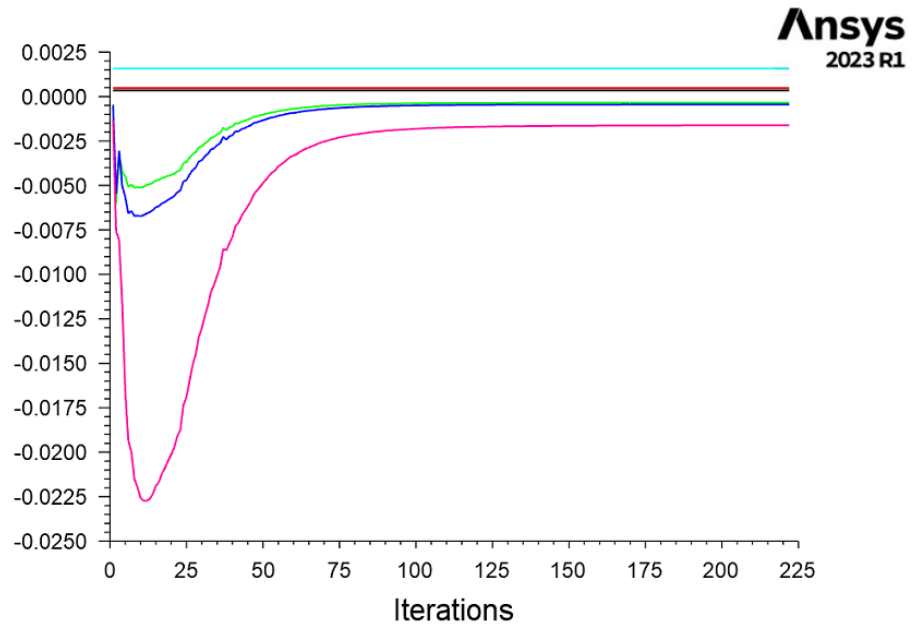
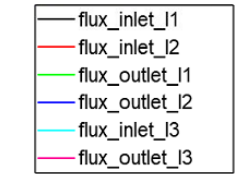
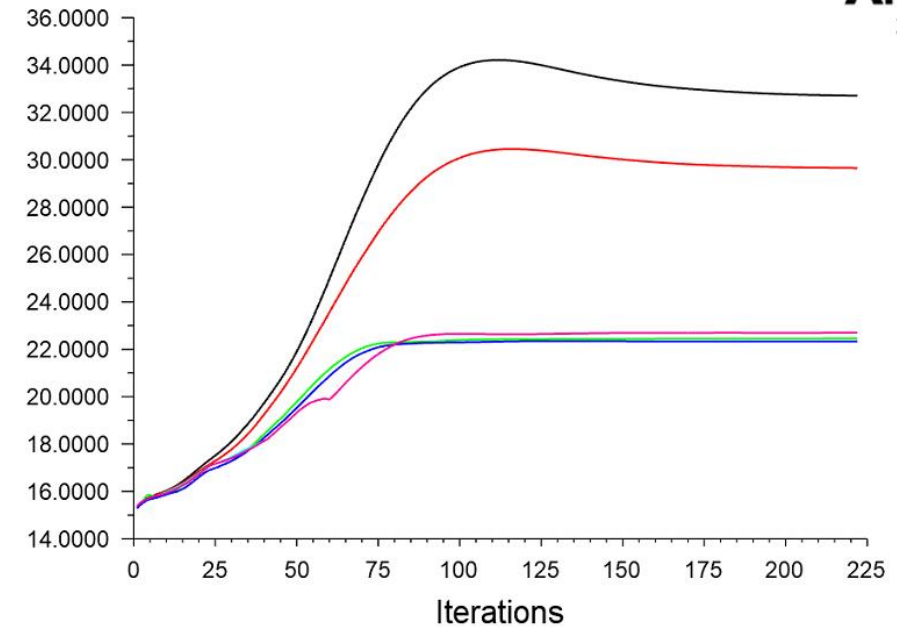
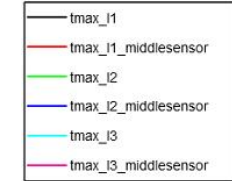
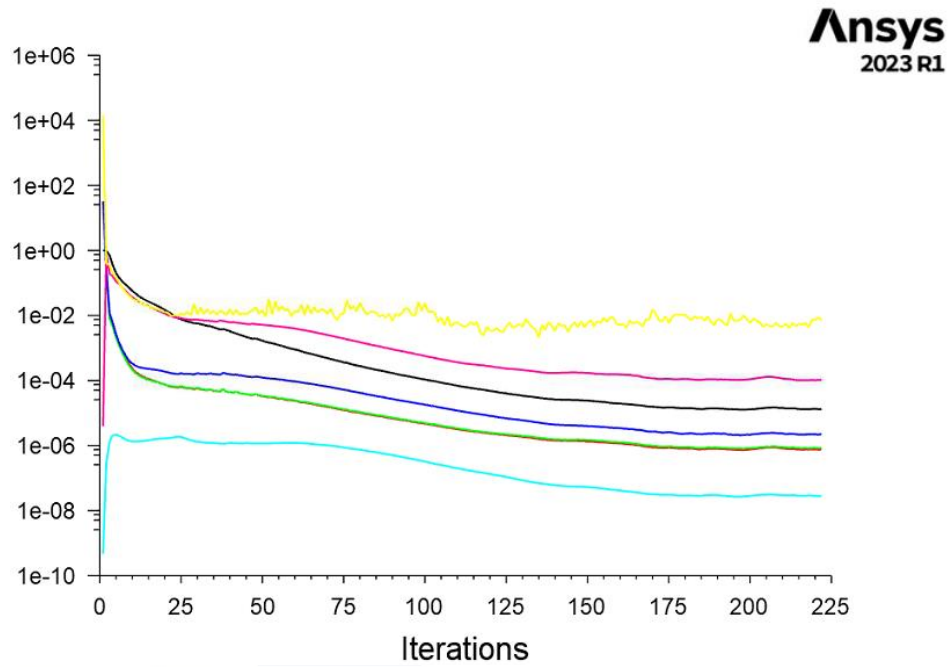
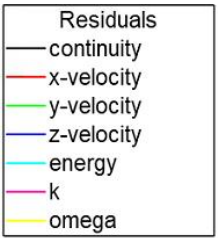


Both solid and fluid



# LAYER 1 + LAYER 2 + LAYER 3 residulas

8-10 hours for convergence

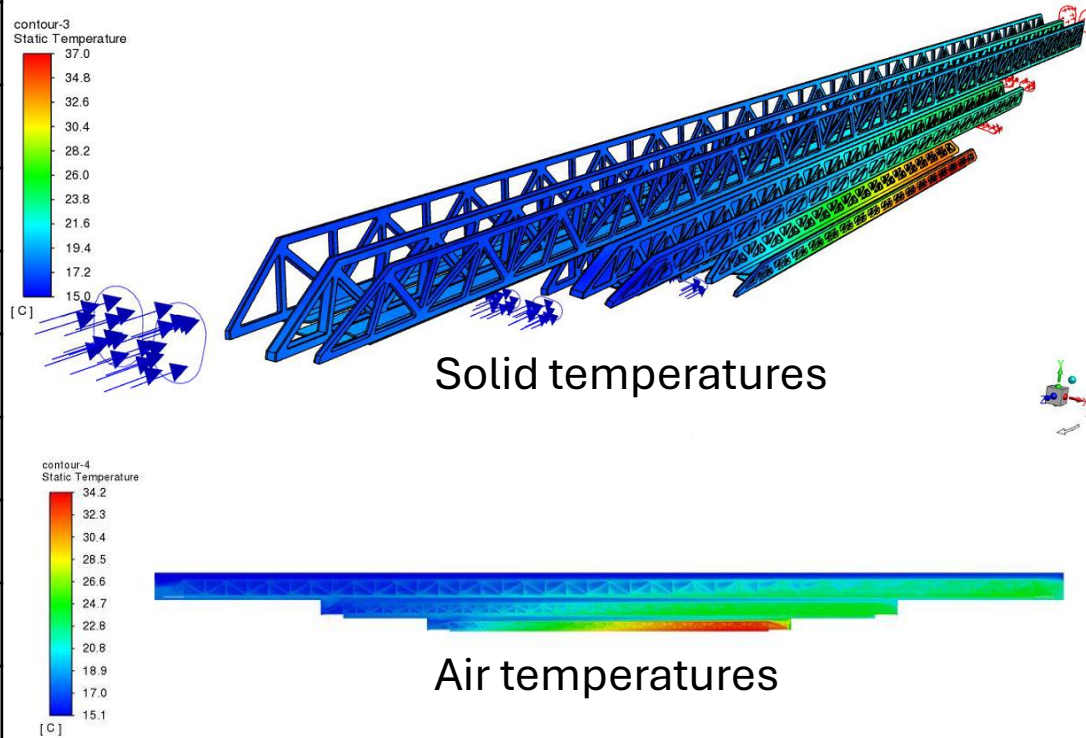


# RESULTS

## INPUTS

$V_{in}(\text{layer1})$	10 [m/s]
$V_{in}(\text{layer2})$	10 [m/s]
$V_{in}(\text{layer3})$	10 [m/s]
$A_{in}(\text{layer1})$	$2 \times 9.50 \text{E-}6$ [m <sup>2</sup> ]
$A_{in}(\text{layer2})$	$2 \times 1.31 \text{E-}5$ [m <sup>2</sup> ]
$A_{in}(\text{layer3})$	$2 \times 4.33 \text{E-}5$ [m <sup>2</sup> ]
$Q_{TOT}(\text{layer1})$	1.6 [W]
$Q_{TOT}(\text{layer2})$	2.7 [W]
$Q_{TOT}(\text{layer3})$	4.3 [W]
$T_{air\_in}$	15 [°C]

Sensors in layer 1 are the warmest (lower air mass flow)



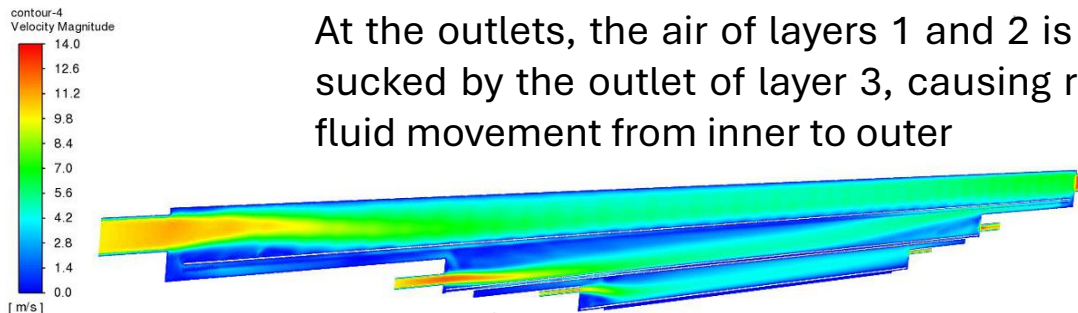
Solid temperatures

Air temperatures

## OUTPUTS

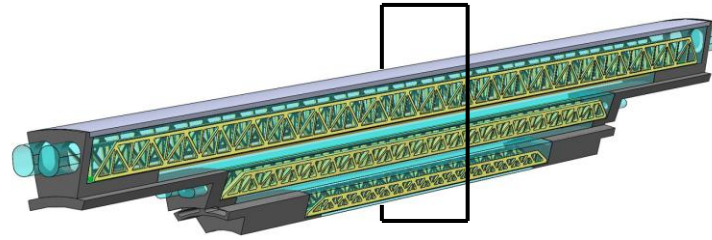
$T_{sens\_max}(\text{layer1})$	<b>34.4 [°C]</b>
$T_{sens\_max}(\text{layer2})$	<b>25.0 [°C]</b>
$T_{sens\_max}(\text{layer3})$	<b>25.3 [°C]</b>
$T_{air\_outlet}(\text{layer1})$	22.3 [°C]
$T_{air\_outlet}(\text{layer2})$	22.5 [°C]
$T_{air\_outlet}(\text{layer3})$	19.4 [°C]
$V_{media\_aria}(\text{layer1})$	2.8 [m/s]
$V_{media\_aria}(\text{layer2})$	2.9 [m/s]
$V_{media\_aria}(\text{layer3})$	3.9 [m/s]
$M_{outlet}(\text{layer1})$	0.00022 [Kg/s]
$M_{outlet}(\text{layer2})$	0.00029 [Kg/s]
$M_{outlet}(\text{layer3})$	0.00109 [Kg/s]

At the outlets, the air of layers 1 and 2 is a bit sucked by the outlet of layer 3, causing radial fluid movement from inner to outer

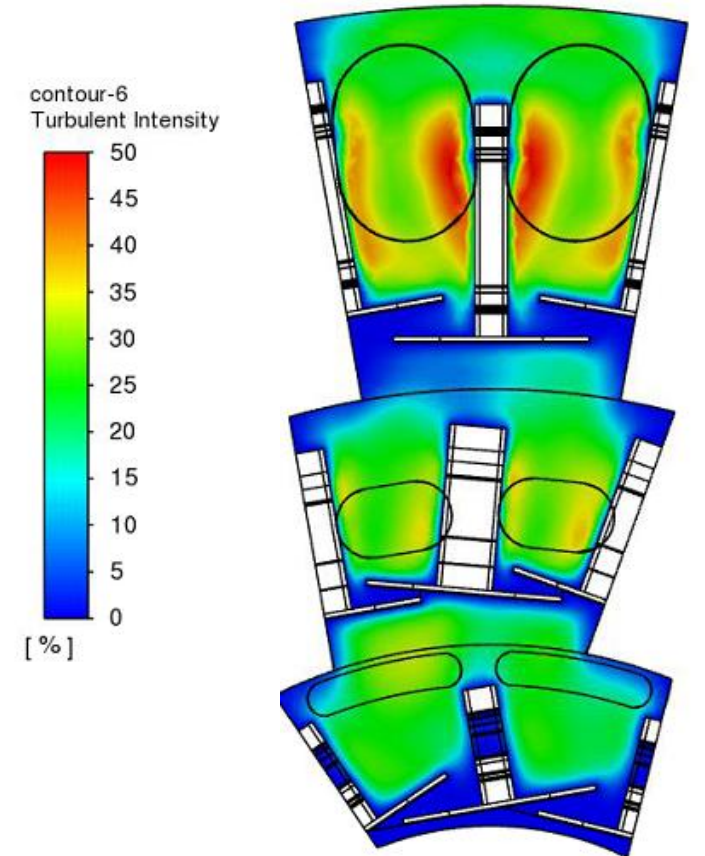
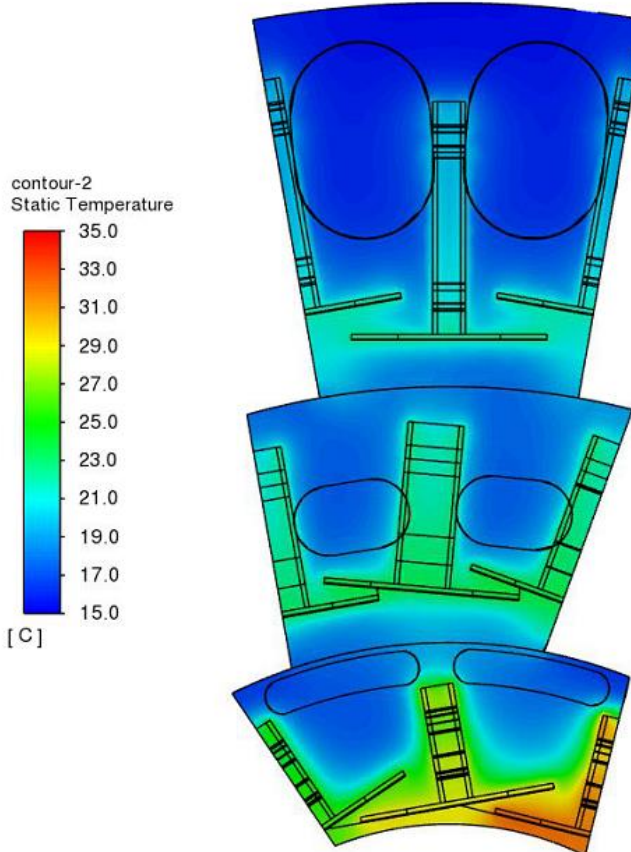
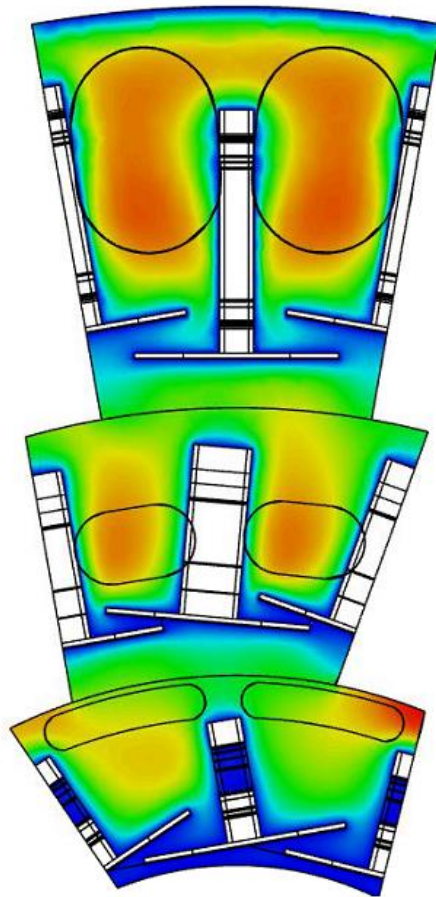


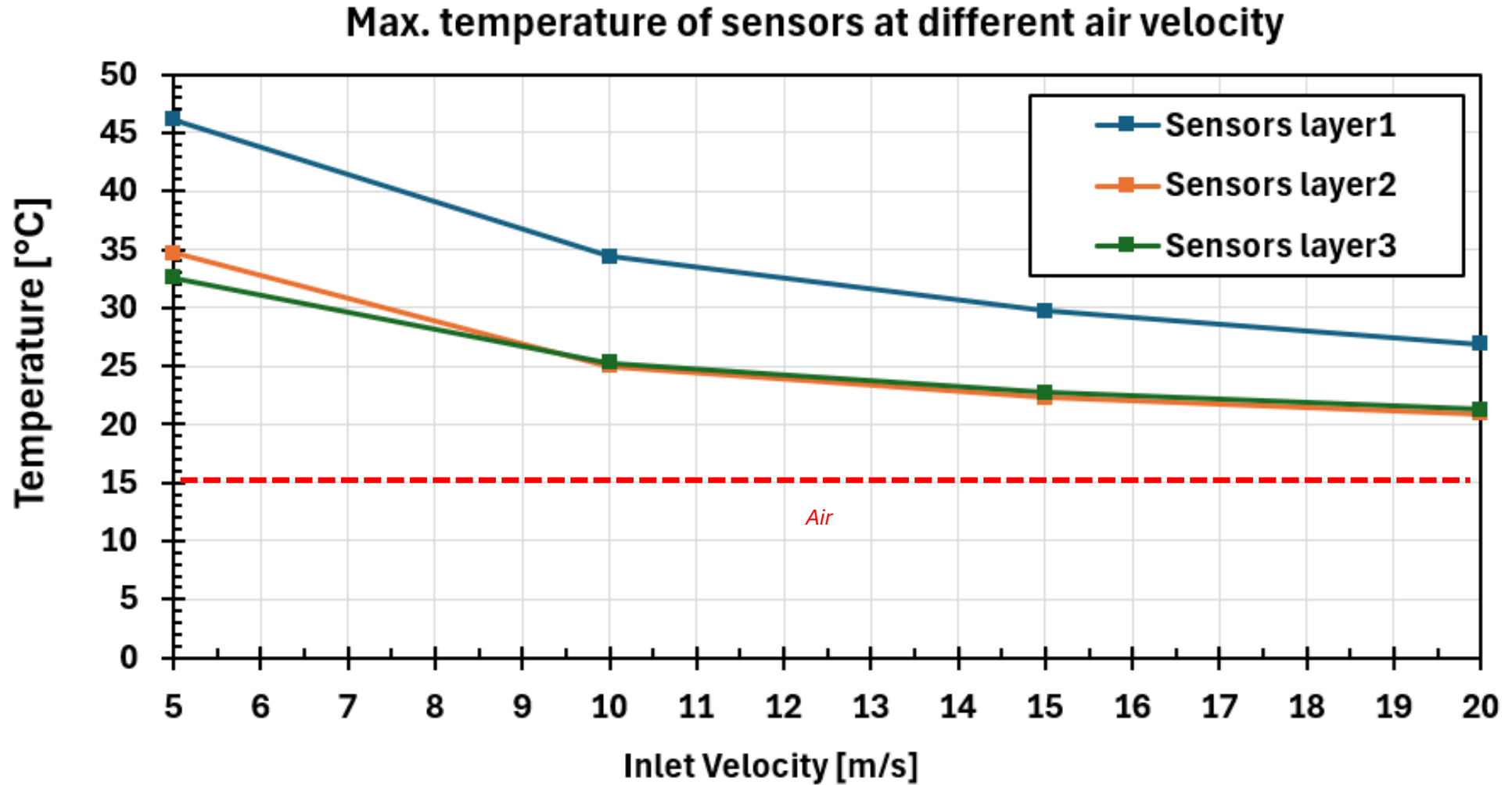
- There is no significant difference in temperature on layer 3 compared to the single layer model (26°C).





Section plane





$$T_{air} = 15^{\circ}\text{C}$$



- The feasibility of a model that simultaneously simulates the 3 layers of the Silicon Inner Vertex Detector is shown.
- **Max.  $\Delta T$  between air and sensors about 10°C for layer 3 and 2, and 20°C for layer 1**, for air inlet at 10 m/s.
  - Encouraging results for the feasibility study.
  - Inlets for layer 1 and 2 are not yet engineered (low flow in layer 1).
  - Some cross-talk found between air flow of different layers, not changing significantly the results respect to the layer-by-layer simulations.
- Next steps: it is crucial to study manifold and routings of air channels.
  - **The air has the potential to cool the vertex, without significant mechanical displacements**, see a previous talk on the argument:  
[https://indico.cern.ch/event/1336746/contributions/5922977/attachments/2867651/5019790/FTDM\\_2024\\_Turrioni.pdf](https://indico.cern.ch/event/1336746/contributions/5922977/attachments/2867651/5019790/FTDM_2024_Turrioni.pdf)
  - The most influential current boundary condition is that the average velocity at each inlet hole is 10 m/s: in real conditions the speed in the openings will change according to the pressure drop and the overall geometry.
  - The main issue is the fluid dynamic optimisation of the air route, more than its thermal capability of dissipating the heat.

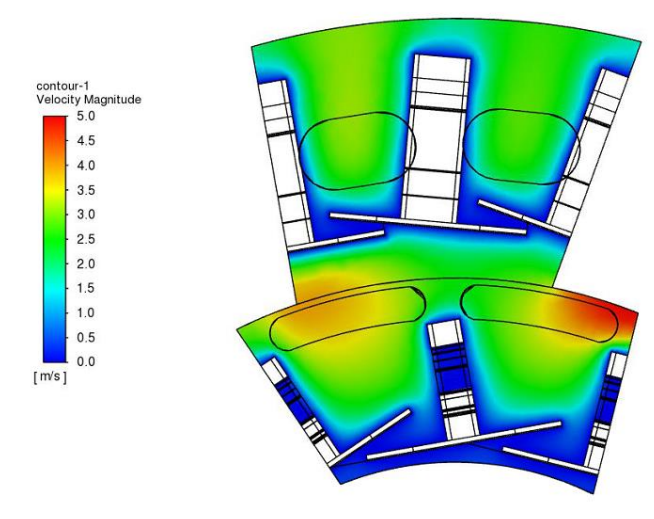
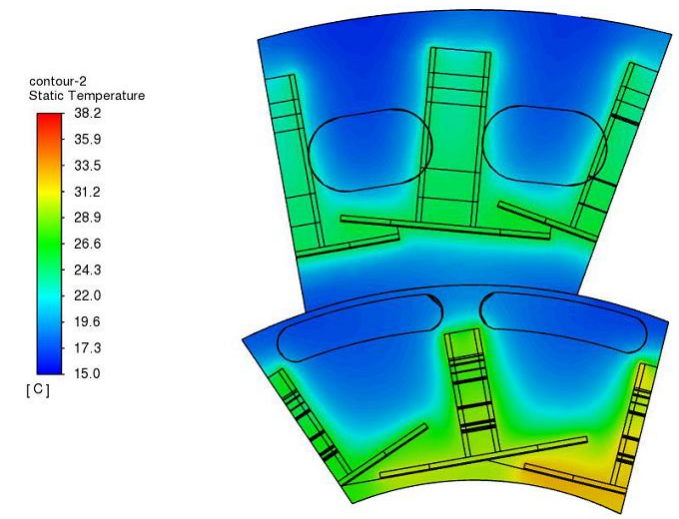
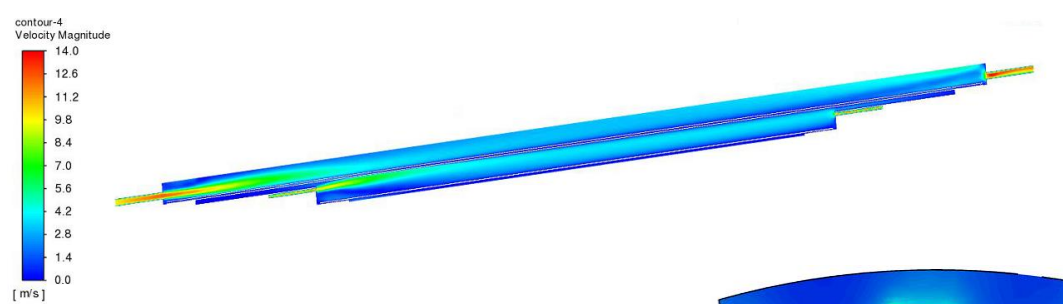
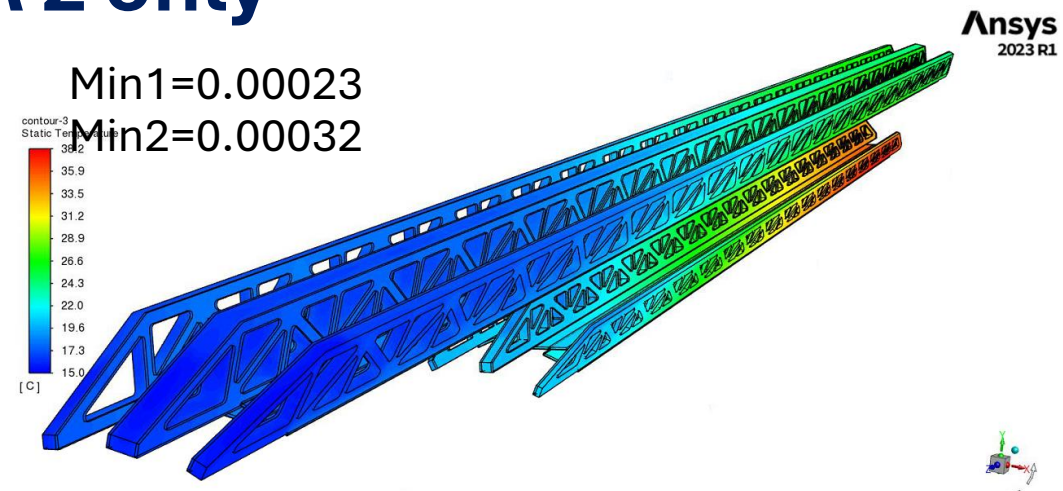
BACKUP



# LAYER 1 + LAYER 2 only

INPUT	
$V_{in}(\text{layer1})$	10 [m/s]
$V_{in}(\text{layer2})$	10 [m/s]
$A_{in}(\text{layer1})$	$2 \times 9.5 \text{E-}6$ [m <sup>2</sup> ]
$A_{in}(\text{layer2})$	$2 \times 1.31 \text{E-}5$ [m <sup>2</sup> ]
$Q_{in}(\text{layer1})$	1.6 [W]
$Q_{in}(\text{layer2})$	2.66 [W]
$T_{air\_in}$	15 [°C]

MATERIALS [K]	
Silicon	148 [W/mK]
Flex circuit	0.3 [W/mK]
CF through	2 [W/mK]
CF in-plane	180 [W/mK]
Rohacell	0.03 W/mK]



OUTPUT 2 layer	
$T_{sens\_max}(\text{layer1})$	35.5 [°C]
$T_{sens\_max}(\text{layer2})$	27.8 [°C]
$T_{air\_outlet}(\text{layer1})$	22.9 [°C]
$T_{air\_outlet}(\text{layer2})$	22.6 [°C]
$V_{media\_aria}(\text{layer1})$	2.4 [m/s]
$V_{media\_aria}(\text{layer2})$	2.3 [m/s]
$M_{outlet}(\text{layer1})$	0.00023 [Kg/s]
$M_{outlet}(\text{layer2})$	0.00032 [Kg/s]